TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC7WZ125FU, TC7WZ125FK**

Dual Bus Buffer with 3-STATE Output

#### **Features**

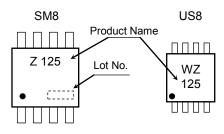
- High output current : ±24 mA (min) at V<sub>CC</sub> = 3 V
- Super high speed operation : tpd = 2.6 ns (typ.)

at V<sub>CC</sub> = 5 V, 50 pF

: V<sub>CC (opr)</sub> = 1.65 to 5.5 V

- Operating voltage range
- 5.5-V tolerant inputs
- 5.5-V power down protection output
- Matches the performance of TC74LCX series when operated at 3.3-V V<sub>CC</sub>.

#### Marking



Tstg

 $\mathsf{T}_\mathsf{L}$ 

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics

Power suply voltage

DC input voltage

DC output voltage

Input diode current

DC output current

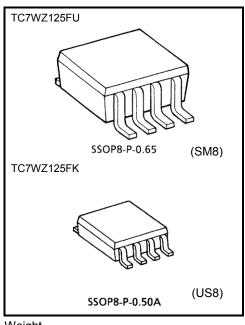
Power dissipation

Storage temperature

Lead temperature (10s)

Output diode current

DC V<sub>CC</sub>/ground current



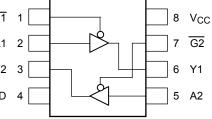
#### Weight

SSOP8-P-0.65 : 0.02 g (typ.) SSOP8-P-0.50A : 0.01 g (typ.)

Symbol	Rating	Unit	Pin Assignments (top view)
V <sub>CC</sub>	–0.5 to 6	V	
$V_{IN}$	–0.5 to 6	V	
V	-0.5 to 6 (Note1)		
V <sub>OUT</sub>	-0.5 to Vcc +0.5 V (Note 2)	V	
I <sub>IK</sub>	-20	mA	
I <sub>OK</sub>	-20 (Note 3)	mA	
I <sub>OUT</sub>	±50	mA	
ICC	±100	mA	
PD	300 (SM8) 200 (US8)	mW	

°C

°C



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

-65 to 150

260

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1:  $V_{CC} = 0V$ 

Note 2: High or Low state. Do not exceed IOUT of absolute maximum ratings.

Note 3: V<sub>OUT</sub> < GND

Start of commercial production 2009-09

## **TOSHIBA**

#### **Truth Table**

Inp	Output			
G	А	Y		
Н	Х	Z		
L	L	L		
L	Н	Н		

X: Don't Care

Z: High Impedance

### **Operating Ranges**

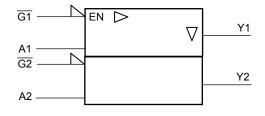
Characteristics	Symbol	Rating	Unit		
Supply voltage		1.65 to 5.5	V		
Supply voltage	V <sub>CC</sub>	1.5 to 5.5 (Note4)	v		
Input voltage	V <sub>IN</sub>	0 to 5.5	V		
	Maxim	0 to 5.5 (Note 5)	V		
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub> (Note 6)	v		
Operating temperature	T <sub>opr</sub>	-40 to 85	°C		
		0 to 20 (V_{CC} = 1.8 V $\pm$ 0.15 V, 2.5 V $\pm$ 0.2 V)			
Input rise and fall time	dt/dv	0 to10 (V_{CC} = 3.3 V $\pm$ 0.3 V)	ns/V		
		0 to 5 (V <sub>CC</sub> = 5.0 V $\pm$ 0.5 V)			

Note 4: Data retention only

Note 5:  $V_{CC} = 0 V$ 

Note 6: High and Low state

#### **IEC Logic Symbol**



2

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics		Sumbol	Teet	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
		Symbol	Test Condition		$V_{CC}(V)$	Min	Тур.	Max	Min	Max	Unit
	High level	VIH	_		1.65 to 1.95	V <sub>CC</sub> × 0.75		_	V <sub>CC</sub> × 0.75	—	V
Input					2.3 to 5.5	V <sub>CC</sub> × 0.7	_	_	V <sub>CC</sub> × 0.7	_	
voltage		VIL	_		1.65 to 1.95	_		V <sub>CC</sub> × 0.25	_	$V_{CC} \times 0.25$	
	Low level				2.3 to 5.5			$V_{CC} \times 0.3$	_	$V_{CC} \times 0.3$	
					1.65	1.55	1.65	—	1.55	_	
			V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	2.3	2.2	2.3	—	2.2	—	
		Vон			3.0	2.9	3.0	_	2.9	—	
					4.5	4.4	4.5	_	4.4	—	V
	High level			$I_{OH} = -4 \text{ mA}$	1.65	1.29	1.52	—	1.29	—	
				$I_{OH} = -8 \text{ mA}$	2.3	1.9	2.15	—	1.9	_	
				I <sub>OH</sub> = -16 mA	3.0	2.4	2.8	_	2.4	—	
				I <sub>OH</sub> = -24 mA	3.0	2.3	2.68	_	2.3	—	
Output				I <sub>OH</sub> = -32 mA	4.5	3.8	4.2	_	3.8	—	
voltage	Low level V	V <sub>OL</sub>	VIN = VIH or VIL	I <sub>OL</sub> = 100 μA	1.65	_	0	0.1	_	0.1	
					2.3		0	0.1	_	0.1	
					3.0	_	0	0.1	—	0.1	
					4.5	—	0	0.1	_	0.1	
				$I_{OL} = 4 \text{ mA}$	1.65	—	0.08	0.24	_	0.24	
				I <sub>OL</sub> = 8 mA	2.3	—	0.1	0.3	_	0.3	
				I <sub>OL</sub> = 16 mA	3.0	-	0.15	0.4	_	0.4	
				I <sub>OL</sub> = 24 mA	3.0	—	0.22	0.55	_	0.55	
				I <sub>OL</sub> = 32 mA	4.5	—	0.22	0.55	_	0.55	
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	—	_	±1	—	±10	μA
3-state output off-state current		I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5V$		1.65 to 5.5	_	_	±1	_	±10	μA
Power off leakage current		I <sub>OFF</sub>	$V_{\text{IN}}$ or $V_{\text{OU}}$	T = 5.5 V	0.0	_		1	_	10	μA
Quiescent supply current		ICC	V <sub>IN</sub> = 5.5 V or GND		1.65 to 5.5	_		1	_	10	μA

#### AC Characteristics (unless otherwise specified, Input: $t_r = t_f = 3 \text{ ns}$ )

				Ta = 25°C			Ta = -4		
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Unit
		0 45 - 5 D 4140	$1.8\pm0.15$	2.0	5.3	11.0	2.0	11.5	-
			$2.5\pm0.2$	0.8	3.4	7.5	0.8	8.0	
Propagation delay time	$C_L = 15 \text{ pF}, R_L = 1M\Omega$	$3.3\pm 0.3$	0.5	2.5	5.2	0.5	5.5	20	
	t <sub>pHL</sub>		$5.0\pm0.5$	0.5	2.1	4.5	0.5	4.8	ns
		0 50 - F D 5000	$3.3\pm 0.3$	1.5	3.2	5.7	1.5	6.0	
		$C_L = 50 \text{ pF}, R_L = 500\Omega$	$5.0\pm0.5$	0.8	2.6	5.0	0.8	5.3	
		$C_L = 50 \text{ pF}, R_L = 500 \Omega$	$1.8\pm0.15$	2.0	7.0	14.9	2.0	16.6	ns
Output anabla time			$2.5\pm0.2$	1.5	4.6	8.5	1.5	9.0	
			$3.3\pm 0.3$	1.5	3.5	6.2	1.5	6.5	
			$5.0\pm0.5$	0.8	2.8	5.5	0.8	5.8	
	<sup>t</sup> pLZ <sup>t</sup> pHZ	$C_L$ = 50 pF, $R_L$ = 500 $\Omega$	$1.8\pm0.15$	2.0	5.4	11.8	2.0	12.7	ns
Output disable time			$2.5\pm0.2$	1.5	4.0	8.0	1.5	8.5	
			$\textbf{3.3}\pm\textbf{0.3}$	1.0	3.5	5.7	1.0	6.0	
			$5.0\pm0.5$	0.5	2.5	4.7	0.5	5.0	
Input capacitance	C <sub>IN</sub>		0 to 5.5	_	4	_	—	—	pF
Output capacitance	C <sub>OUT</sub>	_	0 to 5.5	—	4	_	—	_	pF
Power dissipation	6	(Note 7)	3.3	—	17	—	_	_	pF
capacitance	C <sub>PD</sub>		5.5	—	24	—	—	—	

Note 7: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

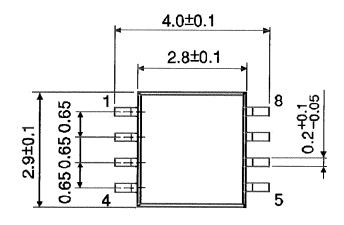
 $I_{CC (opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$ 

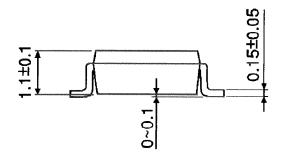
## **TOSHIBA**

#### **Package Dimensions**

SSOP8-P-0.65

Unit : mm





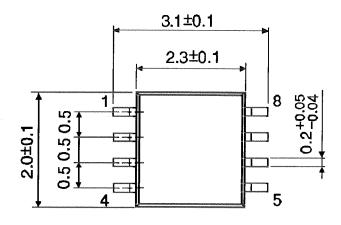
Weight: 0.02 g (typ.)

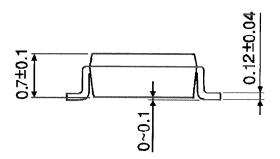
## **TOSHIBA**

#### **Package Dimensions**

SSOP8-P-0.50A

Unit : mm





Weight: 0.01 g (typ.)

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